

ADMISSIONS IN THE FIRST YEAR (SECOND SEMESTER) OF UG PROGRAM (DECEMBER 2012):

Clause 4.0 of the Prospectus 2012-13 provides as under:

The University, if deems fit, may admit students to the second semester of UG programme in January 2013 by conducting its own entrance test in the month of December 2012. This admission will be made for the vacancies that may exist in the first semester of first year. The students admitted in this category shall have to clear all the courses as per the scheme of the discipline of Thapar University, in which she/he is admitted. The eligibility & schedule of the test will be as under:

Eligibility:

1 She/he should have been a student of BE/BTech programme of a recognised Institute/University and have passed 10+2 or equivalent examination from recognized board and have secured at least 60% (55% for SC/ST candidates) marks in aggregate of Mathematics, Physics and Chemistry/Computer science/Biology/Biotechnology.

Or

TU students of BSc-MSc (Dual degree) program having minimum of 60% marks (55% for SC/ST) in Mathematics, Physics and Chemistry/ Computer Science /Biology/Biotechnology at 10+2 level.

- 2 She/he should have appeared in the Entrance Test to be conducted by Thapar University. The cut-off marks in the Entrance test shall be 20% (15% for SC/ST).
- 3 She/he should be a citizen of India.
- 4 She/he should bear a good character and satisfy the prescribed requirements of the University.

Schedule of the admissions

Last date of receipt of application forms

December 10, 2012

Date of ONLINE Entrance Test

December 26-28, 2012

Declaration of the result

Counseling for admission & deposit of fee

January 11, 2013

Test Centres: Online entrance test shall be conducted across country. The information shall be available on the website in November 2012.

Note: No separate letter for Counselling shall be issued.

Admission Procedure:

- Only those candidates shall be considered who shall apply on the prescribed application form on or before the last date.
- Admission shall be made on the merit of the Entrance Test to be conducted by Thapar University.
- 3 Candidate is required to pay tuition fee and other dues at the time of admission.
- 4 There will be only one counselling.
- 5 Candidate leaving after taking admission shall be refunded Caution Money and alumni fee only.
- 15% seats shall be reserved for SC, 7.5% seats for ST category and 3% for physically handicapped category. In case, any seat in reserved category remains vacant, the same shall be converted to the General Category.

Candidates from physically handicapped category are required to produce the Medical Certificate from the Chief Medical Officer of the District concerned, which should indicate the extent of permanent disability in support of their claim. Minimum 40% permanent disability is required to be eligible under this category. Further, the above provisions will be subject to the decision of the Admission Committee of the University whether such a candidate would be able to pursue the studies at the University with the specific disability. The decision of the Admission Committee in this regard shall be final. Although the University has taken care for the facilitation of the physically handicapped but the University will not be liable for providing any special facility that is not available at present. Such candidates may seek admission after satisfying themselves with regard to the existing facilities suitable to them. Should such a candidates feels any difficulty in sitting/teaching arrangements made by the University, she/he should request in writing to DoAA.

- 7 Candidate should bring all the documents in original at the time of Counselling.
- In case, a student of first year of Thapar University gets a seat under this scheme then the seat vacated by such candidate shall be offered to other candidates in the merit list.

Number of seats:

VACANCY POSITION OF BEBTECH PROGRAMME OF 2012 BATCH AS ON 26/10/2012

BRANCH/CATEGORY	GEN	SC(15%)	ST(7.5%)	PH(3%)	TOTAL
BIOTECHNOLOGY	3	1	0	0	04
CHEMICAL ENGINEERING	9	2	1	1	13
CIVIL ENGINEERING	6	1	1	0	08
COMPUTER ENGINEERING	8	2	1	0	11
COMPUTER ENGINEERING CHANDIGARH			1		
CAMPUS	6	1		0	08
ELECTRICAL ENGINEERING	10	2	1	1	14
ELECTRONICS INSTRUMENTATION & CONTROL	4	1	0	0	05
ELECTRONICS COMMUNICATION ENGG.	11	2	1	1	15
MECHANICAL ENGINEERING	0	0	0	0	00
MECHATRONICS	1	0	0	0	01
INDUSTRIAL ENGINEERING	4	1	0	0	05
GRAND TOTAL	62	13	6	3	84

Admission Procedure:

- The application form shall be filled Online at www.thapar.edu. After filling the form, attach Demand Draft of Rs 2500/- (in favour of Thapar University payable at Patiala) with the print out of the application form. The application fee of Rs 2500/- can also be paid online. The application form shall be available shortly on www.thapar.edu.
- Fee to be paid at the time of Counselling:

Without Hostel: Rs 104750/-

With Hostel: Rs 104750/- + Room Rent + Other Dues as mentioned

hereunder:

DETAIL OF FEE	Shared Room
HOSTEL DUES (PER SEMESTER)	
a) Room Rent	14500
b) Hostel Maintenance Charges	3000
c) Electricity Charges	4500
TOTAL HOSTEL DUES (Rs)	Rs 22000

In addition Rs 3500/- are to be deposited to Mess manager of Hostel allotted.

11 Candidate should bring all the documents in original at the time of Counselling. The original documents shall be returned to the candidate except Medical fitness, Migration and Income certificate.

Documents required at the time of Counselling:

Candidates must bring with them following original certificates and a set of attested copies of all the certificates at the time of admission (Counselling).

- 10+2 DMC
- Matriculation/Higher Secondary Certificate showing Date of Birth
- Admit Card of Entrance Test conducted by Thapar University
- Character Certificate
- Medical Fitness Certificate
- Proof of admission in first semester of BE/BTech (Recent Bonafide student certificate)
- Affidavit required in case of discontinuity of studies
- Migration Certificate
- Income Certificate
- Result card of AIEEE(or any other test, if not appeared in AIEEE)
- Candidates are advised to bring completely filled 'Check List Proforma' available hereunder at the time of Counselling. Also attach self attested copies/original of the following documents with 'Check List Proforma'
 - IMPORTANT NOTE: The existing Thapar University students, who will be attending this counseling shall be required to deposit only those documents (from the above mentioned list) which have not been deposited by them earlier. In addition, they shall be required to show the receipt of deposit fee of the second semester of session 2012-13 alongwith Rs 6000/- as admission fee to be deposited at the time of counseling.

- In case, a student of first year of Thapar University gets a seat under this scheme then the seat vacated by such candidate shall be offered to other candidates in the merit list.
- 13 Candidate should bring all the documents in original at the time of Counselling.
- Every candidate must indicate in his/her application the category of seat for which he/she wants to apply. If no mention is made about the category, the candidate will be considered only for the general category. No candidate will be considered for admission against a reserved category for which he/she has not applied.
- Incomplete application in any manner and received after the due date/time will be rejected. The University does not take any responsibility for postal delay or loss in transit of the application form.
- The specimen of the format of the required certificates are available at end for the guidance of candidates. Each certificate must be submitted on the prescribed format and must be issued by the competent authority as mentioned, under proper seal/stamp of their office on a date prior to or on the last date for submission of application form.
- If in the application form it is found that a candidate has concealed, suppressed or distorted any informaton/fact which would have rendered him/her ineligible to take the **Entrance Test,** his/her result of the test and also admission to the University, if granted, shall stand cancelled, and he/she will have no claim, whatsoever, against the University.
- In case of any dispute, the decision of the Director, TU, Patiala shall be final and binding on the candidates.
- The provisions may be changed by the competent authority without any notice.
- Admitted candidates will have to submit the migration certificate from the earlier University/Board within a month of their admission.

IMPORTANT INSTRUCTIONS:

- 1 The fee of **Rs 2500/-** can be deposited through DD or Online only.
- The candidate must send a photocopy of the result card of AIEEE alongwith the application form. If not appeared in AIEEE then send the copy of result card of any other test in which appeared.
- The candidate must send photocopy of the result card of 10+2 alongwith the application form.
- The complete form alongwith DD, photocopies of AIEEE & 10+2 must be sent at following address:

Incharge Admission Cell Academic Section Thapar University Patiala-147004 Punjab (India)

- In case of a tie among candidates securing equal marks in the merit list, the same will be broken in accordance with the following criteria:
 - (a) Candidate senior in age shall rank higher in order of merit.
 - (b) In the case of a tie in age also, a candidate getting higher percentage of marks in the qualifying examination shall be ranked higher in order of merit.

(c) In the case of a tie in percentage of marks in the qualifying examination also, a candidate securing higher percentage of marks in matriculation/secondary or equivalent examination shall rank higher in order of merit.

6 ADMIT CARD

Candidates shall be able to generate 'Admit Card' on www.thapar.edu provided their DD alongwith print out of application form reaches Thapar University in time. The login id and password created by candidate at the time of filling the application form shall be used to register for generation of Admit card.

Important instructions for candidates for Generation of admit card: Once your documents are received and approved by the university, you will have to go to this same link and do the booking for your Online exam.

The booking of test centre can be done from **November 20, 2012 to December 15, 2012**, hence you can generate your Exam ADMIT CARD from **November 20, 2012 to December 15, 2012**.

After registering, the candidate shall take out two print outs of 'Admit Card", paste latest photograph on each and then come to the Entrance test centre. Alongwith admit cards, the candidate will also carry any one of the identity proof (Original) with him/her like Passport/Voter I Card/ PAN Card/ Driving License/Aadhaar. One copy of the Admit card shall be retained by the Entrance Test centre. The candidate shall keep the other copy (duly acknowledged by the examiner at test centre) to be shown at the time of document checking

- While registering for ONLINE entrance test on our website, the candidate shall choose entrance test centre of his/her choice from the available list and any one slot available in the test period given above i.e. (December 26-28, 2012). Once slot is chosen, it cannot be changed thereafter.
- 8 Filling of valid mobile number is mandatory.

GENERAL INFORMATION REGARDING BE/BTECH-DECEMBER 2012 ADMISSIONS INCLUDING ENTRANCE TEST SYLLABUS

Information for:

Structure of the Entrance Test: It will be of 3 hours duration and shall contain 150 Objective/Multiplie choice questions of 1 mark each. 1/4 mark shall be deducted for every wrong answer.:

Compi	ulsory subjects	Number of Questions
1	English	20
2	Mathematics	20
3	Physics	20
4	Chemistry	20
Any tw	o from following (S.No 5-7)	
5	Solid Mechanics	20
6	Computer Programming	20
7	Electrical and Electronic Science	20
Any tw	o from following (S.No 8-10)	
8	Engineering Graphics	15
9	Thermodynamics	15
10	Manufacturing Process	15
	TOTAL	150

ENGLISH

Communicative grammar-Spotting errors related to nouns, pronouns, adjective and adverbs. Changing voice from active to passive and Passive to Active. Idioms and phrases; Words often confused; One word substitutes; Formation of words (suffixes, prefixes and derivatives)

Written English- Types of writing (narrative, expository, analytical, descriptive); Structure of a paragraph; Fundamentals of letter writing.

Reading Skills -Process of reading; Various types of reading skills; Strategies to become an effective reader.

Speaking and Listening Skills-Elements of an effective talk; Oral presentations and designing & using audio visual aids; Process of listening; Recognition of barriers to listening; Developing good listening skills; Role of non verbal cues in speaking and listening.

Physics

Electromagnetic Waves: Introduction, Maxwell's equations in differential and integral forms, Concept of displacement current, Electromagnetic wave equations for free space, Conducting and dielectric medium, Poynting theorem, Concept of wave guides.

Light Waves: Interference: thin films, wedge-shaped films, non-reflecting films, Newton rings, Michelson interferometer, Diffraction: single, double and multiple slits, Dispersive and resolving powers. Polarization, its production, and detection.

Quantum Mechanics: Origin of quantum hypothesis, de-Broglie hypothesis of matter waves, Uncertainity principle, Wave function and wave mechanics, Schrodinger equation: steady state form, Quantum mechanical operators, Expectation value, One dimensional solutions: zero potential, step potential, potential barrier and potential well.

Laser and Fiber Optics: Basic concepts, Laser properties, Laser systems: ruby, Nd:YAG, He-Ne and semiconductor lasers, Optical fiber, Basic theory, Acceptance angle, Numerical Aperture, Normalised Frequency, Mode of propagating; materials dispersion and pulse dispersion in optical fiber; fiber connectors, splicers and couplers; application of optical fiber.

Magnetic Materials and superconductivity: Classification of magnetic materials, Types of magnetism, Magnetic anisotropy and magnetostriction, Magnetic domain, Hard and soft magnetic materials, Ferrites and their applications, Basic ideas of superconductivity, Type I and Type –II superconductors and their applications.

Chemistry

Water and its treatment: Specifications of water for different uses, Water for domestic uses, Different methods of water softening, Boiler feed water, Desalination of water

Electrochemistry: Migration of ions, Transference number, Diffusion and ionic mobility, Debye Huckel theory; Types of electrodes, Concentration cells with and without transference, Potentiometric titirations and conductometric titrations.

Phase Rule: Definitions of terms, Derivation of phase rule, One component and two component systems.

Polymers: Basic concepts, Classification and industrial application.

Spectroscopic Techniques: Law of absorption of light, Limitations and applications of Beer's law, Grotthus-Draper Law, Stark Einstein Law; Jablonski diagram, Types of molecular spectra, Introduction to atomic spectroscopy, Principle and applications of atomic absorption spectroscopy, UV/VIS, IR and NMR spectroscopy

Corrosion and its prevention: Corrosion, Different types of corrosion, Prevention of corrosion

MATHEMATICS

Applications of derivatives: Mean value theorems and their geometrical interpretation, Cartesian graphing using first and second order derivatives, polar curves, Polar equations for conic sections. Differential calculus of functions of several variables with applications, directional derivative, homogeneous functions and Euler's theorem, Jacobians, maxima and minima of functions of two variables.

Integral Calculus: Fundamental theorem of integral calculus applications of definite integral to area and arc length. Double and triple integration, and their applications to areas and volumes.

Vector Calculus: Differentiation and integration of vector valued functions, velocity, acceleration, tangent, principle normal and binormal vectors, Curvature and Torsion., Gradient, Divergence and Curl. Line integrals, Work, Circulation and Flux. Green's theorem in Plane

Infinite Series: Introduction to sequences and Infinite series, Tests for convergence/divergence. Alternating series, Absolute convergence, conditional convergence, power series and its convergence.

Matrices: Rank and inverse of a matrix, Solution of linear system of equations.

Complex Numbers: De'Moivre's theorem and its applications.

SOLID MECHANICS

Review of Engineering Mechanics: Concept of force, representation and resolution of forces, free body diagrams, analysis of Pin jointed plane trusses.

Simple Stresses and Strains: Stress-strain curves for elastic materials, axial stress and strain, Hookes' law, Young's modulus of elasticity, Bulk modulus of rigidity and Poisson's ratio, relationship between elastic constants, thermal stresses, principal planes and stresses.

Torsion: Concept of shear strain, Torsion of circular and hollow shafts, power transmitted.

Bending Moment and Shear force Diagrams: Types of beams, supports and loadings, sign conventions, relationship between load, shear force and bending moment, graphical plots of Shear Force and Bending Moments.

Bending and shear Stresses: Theory of simple bending, determination of stresses in simple and built -up sections, flitched beams, variation of shear stress across the depth of various beam sections

COMPUTER PROGRAMMING

Introductory Concepts: Elements of Computer Processing, Basic Concepts of Hardware and Software, Problem solving with Algorithms and Flowchart, Types of Programming Languages, Basic DOS and Linux Commands.

C Programming Concepts and Operators, Hierarchy of operators, Header files, Data input and output, Control statements: loops and Decision statements, Preprocessor directives, Storage classes, Array, Strings, Structures, Union, Enumerations, Functions, Fundamentals of pointers, File Handling in C, Command line arguments.

ELECTRICAL AND ELECTRONIC SCIENCE

Basic electrical quantities, electric circuit elements and their V-I relations, KCL, KVL, Ohm's law, combination of circuit elements, temperature dependency of resistance.

Mesh and Nodal Analysis, Star-Delta Transformation, Superposition theorem, Thevenin's and Norton's theorems, Maximum power transfer theorem, Transient (step) response of RL and RC series circuits.

Concept of Phasor, sinusoidal steady state response of RL, RC & RLC series and parallel circuits, power and power factors, resonance in series and parallel circuits, bandwidth, loss tangent and quality factor.

Concepts of magnetic circuits, analogy of magnetic circuit with electric circuit, B-H curve, ampere-turn calculation, constructional features and operating principle of single phase transformer and DC machine, characteristics and applications of DC motor.

Diode applications and characteristics, transistor operating modes and characteristics in various configurations, colour coding of low power resistors.

ENGINEERING GRAPHICS

Introduction and use of drafting tools, Lettering, Dimensions and standards, Projection systems, Orthographic projection of points and lines on reference planes, Auxiliary planes and their applications, Projection of surfaces, Projection and sections of solids, Intersection of solids, Development of surfaces, Orthographic projections from pictorial views, Isometric views. Missing lines and views

THERMODYNAMICS

Introduction: Basic Concepts: System, Control Volume, Surrounding, Boundaries, Universe, Types of Systems, Macroscopic and Microscopic viewpoints, Concept of Continuum, Thermodynamic Equilibrium, State, Property, Process: Flow and non flow process, cycle concept of work and heat, Specific heats, Zeroth law, Energy and its form, pure substance, Thermodynamic diagrams, triple point, steam tables and their use.

First Law of Thermodynamics: Concept of internal energy & enthalpy, energy equation as applied to a close and open system, PMM of First kind. Transient flow processes. Charging and discharging of tanks.

Limitations of the First Law – Thermal Reservoir, Heat Engine, Heat pump, Parameters of performance, Second Law of Thermodynamics, Kelvin-Planck and Clausius Statements and their Equivalence/Corollaries, PMM of Second kind, Carnot's principle, Carnot cycle and its specialties, Thermodynamic scale of Temperature, Second law analysis of control volume.

Clausius Inequality, Entropy, Principle of Entropy Increase – Energy Equation. Various cycles and systems: Rankine cycle, vapour compression refrigeration cycle, Air standard cycles: Otto, Diesel, Dual, Brayton cycles.

MANUFACTURING PROCESSES

Introduction: Common engineering materials and their important mechanical and manufacturing properties. General classification of manufacturing processes

Metal Casting: Principles of metal casting, Patterns, their functions, types, materials and pattern allowances, Characteristics of molding sand, Types of cores, chaplets and chills; their materials and functions.

Metal Forming And Shearing: Forging, rolling, drawing, extrusion, bending, spinning, embossing, shearing, piercing and blanking.

Machining Processes: Principles of metal cutting, cutting tools, their materials and applications, Geometry of single point cutting tool, Basic machine tools and their applications. Introduction to non-traditional machining processes (EDM, USM, CHM, ECM, and LBM).

Joining Processes: Electric arc, Gas, Resistance and Thermit welding, Soldering, Brazing and Braze welding, Adhesive bonding, Mechanical fastening.



(Formerly Thapar Institute of Engineering and Technology, Patiala)

CHECK LIST OF DOCUMENTS (BE/BTech Admission)

Dated: January 11, 2013

(To be filled by the candidate & is required to submit at the time of counselling alongwith self attested copies of following documents)

Log	in id	RANK	CATEGORY	 Self-attested Copy
01.			OMC with atleast 60% man	attached cks in PCM
	(55% for SC	(/ST)		Yes/No
02.	Matriculation	n/Higher Secondary C	ertificate (Date of Birth)	Yes/No
03.	Entrance Tes	t Admit Card		Yes/No
04.	Entrance Tes	t Result with atleast 2	0% marks (15% for SC/ST	Υes/No
05.	Character Ce	rtificate		Yes/No
06.	Medical Fitn	ess Certificate		Yes/No
07.		tegory Certificate on t the competent authori	he prescribed proforma and ty	d Yes/No
08.	Self statemen	nt required in case of	discontinuity of studies	Yes/No
09.	Migration Co	ertificate		Yes/No
10.	Income Certi	ficate		Yes/No
11.	Anti Ragging	g affidavit attached		Yes/No
12.	Result card o	of AIEEE or any other	entrance test (if not appear	red in AIEEE) Yes/No
13.	Proof of admi	ssion in BE/BTech (R	ecent Bonafide student cert	tificate) Yes/No
I		llready student of Tha		
			Group	
he fo	llowing docu	y):To be filled at th ments are required:	e time of counselling	Signature of the candidate
			_	
shall or t	submit above before	e documents	-	



FORMAT OF CERTIFICATE OF SCHEDULED CASTE

Desp	atch No		Date
1.	It is certified that Mr./Msson/daughter		0
	village/town	district/division	which has been recognised as
2.	Mr./Ms		•
P	Place	Signature	
Ι	Date	Designation	
S	State	(with official seal of the offi	cer concerned)

SCHEDULED TRIBE CERTIFICATE

Same as for Scheduled Castes Candidates.

FORMAT OF MEDICAL CERTIFICATE

I certify that I have carefully examined Mr./Misson/daughter of Sh	
His/her Chest Measurement is	Unexpanded Cm
	Expanded Cm
His/her eyesight is upto the prescribed standards.	
Details of glasses, if worn	
He/she has no disease or mental or bodily infirmity active outdoor service.	unfitting or likely to unfit him/her in the future for
Marks of identification	
Thumb impression	
HEPATITIS "B" IMMUNISATION? Dated	Yes No
	Signature of Gazetted Medical Officer (with official Seal)
Self attested passport size recent photograph	

Signature of Candidate

FORMAT OF

CERTIFICATE BY PRINCIPAL OF THE INSTITUTION LAST ATTENDED

Certified that Mr./Ms			son/daughter of						Sh.			
				bears	а	good	moral	character	and	according	to	the
School/College	record,	his/her	date		of		birth	is		(in	WC	ords)
								and h	is/her	sUniversit	y/Bo	oard
Registration No. is												
Place								Signa	tura			
								J				
Date								(with o	officia	ıl seal)		

FORMAT OF ANTIRAGGING AFFIDAVIT BY PARENT/ GUARDIAN

I, Mr. /Mrs./Ms.	(full name of parent /
guardian) father/mother/guardian of	
registration/ enrolment number), having been admitted to _	(name of the
institution) have received a copy of the UGC Regulations or	Curbing the Menace of ragging in Higher
Educational Institutions, 2009, (hereinafter called the "Regul	ation"), carefully read and fully understood
the provisions contained in the said Regulations.	
I have, in particular, perused clause 3 of the Regula ragging.	ations and am aware as to what constitutes
3. I have also, in particular, perused clause 7 and clause	e 9.1 of the Regulations and am fully aware
of the penal and administration action that is liable to	be taken against my ward in case he/she is
found guilty of or abetting ragging, actively or passive ragging.	ely, or being part of a conspiracy to promote
4. I hereby solemnly aver and undertake that :	
1. My ward will not indulge in any behaviour under clause 3 of the Regulations.	or act that may be constituted as ragging
2. My ward will not participate in or abet or promission that may be constituted as ragging u	
 I hereby affirm that, if found guilty of ragging, my clause 9.1 of the Regulations, without prejudice to a against my ward under any penal law or any law for the 	ny other criminal action that may be taken
6. I hereby declare that my ward has not been expelled o	r debarred from admission in any institution
in the country on account of being found guilty of promote, ragging; and further affirm that, in case admission of my ward is liable to be cancelled.	
Declared this day of mo	nth ofyear.
Signature of deponent	
Name:	
Address:	

Telephone / Mobile No.:			
VERIFICATION			
Verified that the contents of this aff	idavit are true to the best of my kr	nowledge and no part	of the affidavit
is false and nothing has been concea	aled or misstated therein.		
Verified at	(place) on this the	day of	of month,
year.			
Signature of deponent			
Solemnly affirmed and signed in	my presence on this the	day of	month of
year after reading t	he contents of this affidavit.		

OATH COMMISSIONER

FORMAT OF ANTIRAGGING AFFIDAVIT BY THE STUDENT

I,		(full	name	of s	tudent	with
admiss	ion/ registration/ enrolment number), S/o D/o Mr. / Mrs./ Ms.					(full
	of parent / guardian) having been admitted toion) have received a copy of the UGC Regulations on Curbing					
Educat	ional Institutions, 2009, (hereinafter called the "Regulation"),	carefull	y read a	nd full	y under	stood
the pro	visions contained in the said Regulations.					
2.	I have, in particular, perused clause 3 of the Regulations an ragging.	d am a	ware as	to wh	at const	itutes
3.	I have also, in particular, perused clause 7 and clause 9.1 of to of the penal and administration action that is liable to be taken guilty of or abetting ragging, actively or passively, or being ragging.	ken aga	inst me	in cas	e I am i	found
4.	I hereby solemnly aver and undertake that:					
	 I will not indulge in any behaviour or act that may be of the Regulations. 	constitu	ited as r	agging	under o	clause
	2. I will not participate in or abet or propagate through that may be constituted as ragging under clause 3 of the	•		mission	n or omi	ission
5.	I hereby affirm that, if found guilty of ragging, I am liable for of the Regulations, without prejudice to any other criminal acunder any penal law or any law for the time being in force.	•		_		
6.	I hereby declare that I have not been expelled or debarred from country on account of being found guilty of, abetting or being ragging; and further affirm that, in case the declaration is four admission is liable to be cancelled.	ig part	of a con	spirac	y to pro	mote,
Declar	ed this day of month of		year.			
Signatu	ure of deponent					

VERIFICATION

Verified that the contents of this	affidavit are true to the best of my ki	nowledge and no part	of the affidavit
is false and nothing has been cor	ncealed or misstated therein.		
Verified at	(place) on this the	day of	of month,
year.			
Signature of deponent			
	in my presence on this the	day of	month of
·			

OATH COMMISSIONER